

# 1.6X0.8mm SMD CHIP LED LAMP

Part Number: KPT-1608SURCK Hyper Red

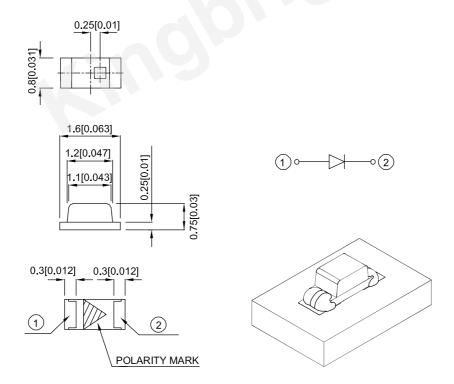
#### **Features**

- 1.6mmX0.8mm SMD LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

# **Description**

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

# **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

DATE: JAN/18/2016 SPEC NO: DSAB3165 **REV NO: V.22A** PAGE: 1 OF 5 **APPROVED: Wynec CHECKED: Allen Liu** DRAWN: M.Liu ERP: 1203001764

# **Selection Guide**

Part No.	Part No. Emitting Color (Material) Lens Typ	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPT-1608SURCK	Hyper Red (AlGaInP)	Water Clear	120	230	- 120°
		Water Clear	*40	*80	

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: +/-15%.

  \* Luminous intensity value is traceable to CIE127-2007 standards.

# Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Emitting Color	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	645		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	I=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	1.95	2.5	V	I=20mA
lr	Reverse Current	Hyper Red		10	uA	V <sub>R</sub> =5V

- Notes:
  1. Wavelength: +/-1nm.
  2. Forward Voltage: +/-0.1V.
  3. Wavelength value is traceable to CIE127-2007 standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

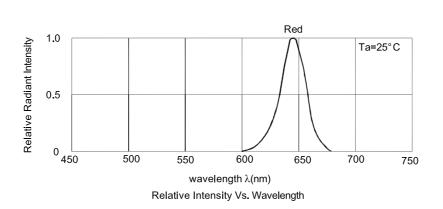
# Absolute Maximum Ratings at TA=25°C

Parameter	Values	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	185	mA	
Electrostatic Discharge Threshold (HBM)	3000	V	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
torage Temperature -40°C To +85°C			

#### Notes:

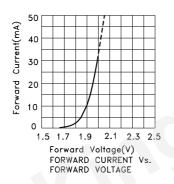
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
  2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity - Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

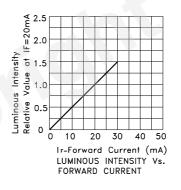
PAGE: 2 OF 5 SPEC NO: DSAB3165 **REV NO: V.22A DATE: JAN/18/2016 APPROVED: Wynec CHECKED: Allen Liu** DRAWN: M.Liu ERP: 1203001764

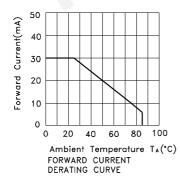


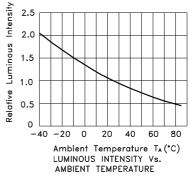
# **Hyper Red**

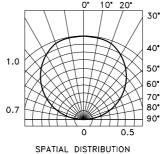
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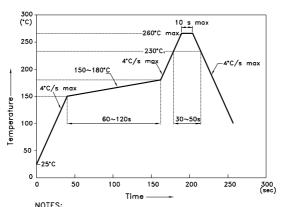
SPEC NO: DSAB3165 REV NO: V.22A
APPROVED: Wynec CHECKED: Allen Liu

DATE: JAN/18/2016 DRAWN: M.Liu PAGE: 3 OF 5 ERP: 1203001764

### KPT-1608SURCK

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



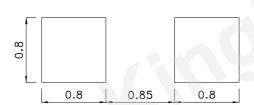
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

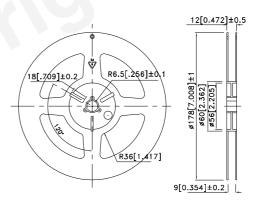
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

  3.Number of reflow process shall be 2 times or less.

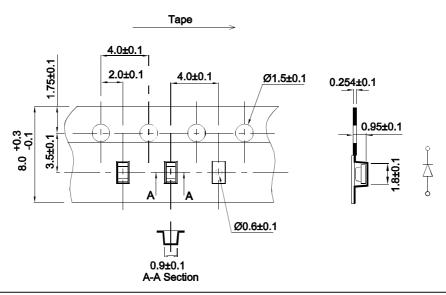
# Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



# **Reel Dimension**



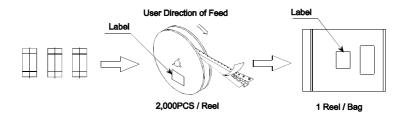
Tape Dimensions (Units: mm)

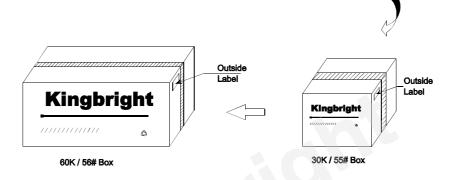


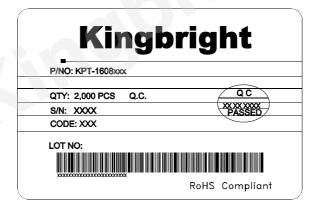
SPEC NO: DSAB3165 APPROVED: Wynec REV NO: V.22A CHECKED: Allen Liu DATE: JAN/18/2016 DRAWN: M.Liu PAGE: 4 OF 5 ERP: 1203001764

# PACKING & LABEL SPECIFICATIONS

# **KPT-1608SURCK**







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 SPEC NO: DSAB3165
 REV NO: V.22A
 DATE: JAN/18/2016
 PAGE: 5 OF 5

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